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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)	Application Number	Unknown 10/739,641	
	Filing Date	Even Date Herewith 12/8/03	
	First Named Inventor	Farrar, Paul	
	Group Art Unit	Unknown >815	
	Examiner Name	Quens, Beth FENTY, Jesse	
Sheet 1 of 5	Attorney Docket No: 1	1303.041US2	

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xaminer Initial	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate
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	Application Number	Unknown 10/730, 641		
	Filing Date	Even Date Herewith 12/8/63		
	First Named Inventor	Farrar, Paul		
	Group Art Unit	Unknown 2815		
	Examiner Name	Owons, Both Fenty, Jesse		
Sheet 2 of 5	Attorney Docket No: 1303.041US2			

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der the Paperwork Reduction Ad of 1995, no persons are required to respond to a collection of information unless it contains a valid OAB control number
Complete if Known Substitute for form 1449A/PTO INFORMATION DISCLOSURE **Application Number** Unknown 10/730,641 STATEMENT BY APPLICANT Filing Date Even Date Herewith (Use as many sheets as necessary) First Named Inventor Farrar, Paul **Group Art Unit** Unknown 2815 **Examiner Name** Owens Beth Feuty J~55e Attorney Docket No: 1303.041US2 Sheet 3 of 5 US-6,268,637 07/31/2001 Gardner, M., et al. 257 522 10/22/1998 Zhou, Mei-Sheng, et 09/11/2001 438 723 04/17/2000 US-6,287,979 781 07/14/1998 Juengling, W, et al. 438 US-6,313,046 11/06/2001 03/02/2000 US-6,313,518 11/06/2001 Ahn, K., et al. 257 632 11/27/2001 Soo, C., et al. 438 645 03/29/1999 US-6,323,125 12/01/2001 Tsai, , et al. 438 624 US-6,331,480 Juengling, W, et al. 257 758 10/19/1997 US-6,333,556 12/25/2001 US-6,342,454 01/29/2002 Hawker, Craig, et al. 438 780 11/16/1999 02/26/2002 Sun, Shih-Wei 438 619 10/09/1997 US-6,350,672 322 09/01/1999 03/05/2002 430 US-6,352,818 Hsieh, H. Babinec, Susan, et 440 10/15/1998 US-6,380,294 04/30/2002 524 296 02/14/2000 US-6.413.827 07/02/2002 Farrar, P. A. 438 US-6,420,261 04/16/2002 Kudo, Hiroshi 438 633 08/31/1999 01/18/2000 438 652 US-6,420,262 07/16/2002 Farrar, P. A. 07/16/2002 Allen, C. S., et al. 521 77 12/10/1999 US-6,420,441 438 584 04/02/1999 US-6,503,818 01/07/2003 Jang, Syun-Ming Sun, Shih-Wei US-2001/0005625 438 634 12/29/2000 06/28/2001 438 619 04/04/2001 US-2001/0014526 08/16/2001 Clevenger, L A., et al. 03/28/2001 US-2001/0019876 09/06/2001 Juengling, W, et al. 438 456 06/27/2001 US-2001/0034117 10/25/2001 Eldridge, J, et al. 438 619 08/02/2001 Juengling, W, et al. 257 758 US-2001/0050438 12/13/2001 10/12/2001 US-2002/0019125 02/14/2001 Juengling, W, et al. 438 631 08/10/2001 US-2002/0037603 03/28/2001 Eldridge, , et al. 438 112 FOREIGN PATENT DOCUMENTS Examiner Intrals Name of Patentee or Applicant of Foreign Document No T² Class Subclass **Publication Date** cited Documen H₀1 21/334 EP-578856A1 07/16/1992 Beuttler, G., et al. **HO1** 17/00 GB-2158995A 11/20/1985 Maile, G. L. Q JP-01-230505 08/24/2001 Kirchhoff, M. H05K 01/03 OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item Cite No 1 Examiner gitials (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. "ACCUSPIN T-18 Flowable Spin-On Polymer (SOP)", AlliedSignal - Advanced

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US Patent & Tradement Office: U.S. DEPARTMENT OF COMMERCE

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Substitute for form 1449APTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)	Complete if Known			
	Application Number	Unknown 10/7 30, 641		
	Filing Date	Even Date Herewith 12/8/03		
	First Named Inventor	Farrar, Paul		
	Group Art Unit	Unknown PP15		
	Examiner Name	Owens, Beth FENTY, TESSE		
Sheet 4 of 5 Attorney Docket No: 1303.04		1303.041US2		

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• EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered, include copy of this form with next communication to applicant, a Applicant's unique citation designation number (optional) 2 Applicant is to place a chock mark here if English tanguage Translation is ettached

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Substitute for form 1449A/PTO INFORMATION DISCLOSURE	Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control Complete if Known			
STATEMENT BY APPLICANT (Use as many sheets as necessary) Sheat 5 of 5	Application Number	Hataewa 10/739,641		
	Filing Date	Even Date Herewith 12/8/03		
	First Named Inventor	Farrar, Paul		
	Group Art Unit	Unknown 2815		
	Examiner Name	Owens, Beth Fenty, Josse		
	Attorney Docket No: 1303.041US2			

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